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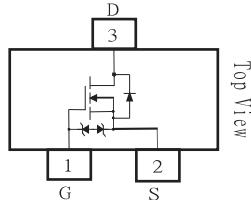
50V N-Channel Enhancement Mode MOSFET - ESD Protected

FEATURES

- $R_{DS(ON)}$, $V_{GS} @ 10V, I_{DS} @ 500mA = 3\Omega$
- $R_{DS(ON)}$, $V_{GS} @ 4.5V, I_{DS} @ 200mA = 4\Omega$
- $R_{DS(ON)}$, $V_{GS} @ 2.5V, I_{DS} @ 100mA = 6\Omega$
- Advanced Trench Process Technology
- High Density Cell Design For Ultra Low On-Resistance
- Very Low Leakage Current In Off Condition
- Specially Designed for Battery Operated Systems, Solid-State Relays
Drivers : Relays, Displays, Lamps, Solenoids, Memories, etc.
- ESD Protected
- ~~Specifically designed for battery operated systems, solid-state relays
Drivers : Relays, displays, lamps, solenoids, memories, etc.~~

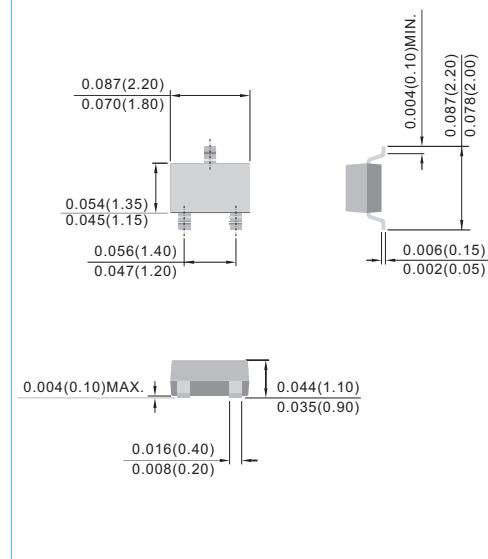
MECHANICAL DATA

- Case: SOT-323 Package
- Terminals : Solderable per MIL-STD-750,Method 2026
- Marking : 38W
- Apporx. Weight: 0.000Gounce*, 0.005 gram*



SOT-323

Unit : inch(mm)



Maximum Ratings and Thermal Characteristics ($T_A=25^\circ C$ unless otherwise noted)

PARAMETER	Symbol	Limit	Units
Drain-Source Voltage	V_{DS}	50	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	300	mA
Pulsed Drain Current ¹⁾	I_{DM}	2000	mA
Maximum Power Dissipation	$T_A=25^\circ C$ $T_A=75^\circ C$	P_D 350 210	mW
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to + 150	°C
Junction-to Ambient Thermal Resistance(PCB mounted) ²⁾	R_{0JA}	357	°C/W

Note: 1. Maximum DC current limited by the package

2. Surface mounted on FR4 board, $t < 5$ sec

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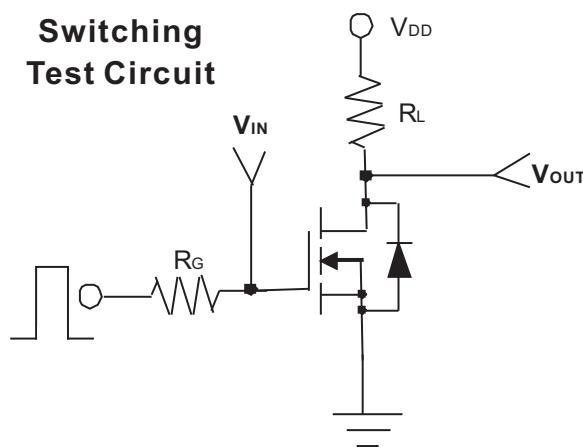


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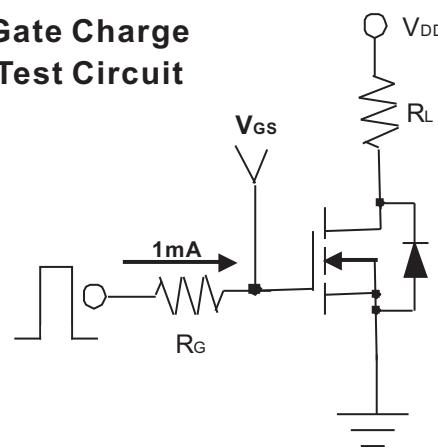
ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Units
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=10\mu A$	50	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.8	-	1.5	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=2.5V, I_D=100mA$	-	2.8	6.0	Ω
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=200mA$	-	1.8	4.0	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=500mA$	-	1.6	3.0	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=50V, V_{GS}=0V$	-	-	1	μA
Gate Body Leakage	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 10	μA
Forward Transconductance	g_{fs}	$V_{DS}=10V, I_D=250mA$	100	-	-	mS
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=25V, I_D=250mA$ $V_{GS}=4.5V$	-	-	1.0	nC
Turn-On Time	t_{on}	$V_{DD}=30V, R_L=100\Omega$ $I_D=300mA, V_{GEN}=10V$ $R_G=6\Omega$	-	-	40	ns
Turn-Off Time	t_{off}		-	-	150	
Input Capacitance	C_{iss}	$V_{DS}=25V, V_{GS}=0V$ $f=1.0MHz$	-	-	50	pF
Output Capacitance	C_{oss}		-	-	10	
Reverse Transfer Capacitance	C_{rss}		-	-	5	
Source-Drain Diode						
Diode Forward Voltage	V_{SD}	$I_S=250mA, V_{GS}=0V$	-	0.82	1.2	V
Continuous Diode Forward Current	I_s	-	-	-	300	mA
Pulse Diode Forward Current	I_{SM}	-	-	-	2000	mA

Switching Test Circuit



Gate Charge Test Circuit





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Typical Characteristics Curves ($T_A=25^\circ\text{C}$,unless otherwise noted)

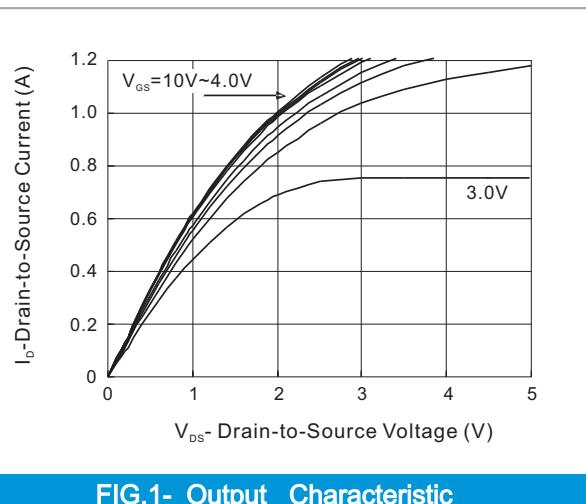


FIG.1- Output Characteristic

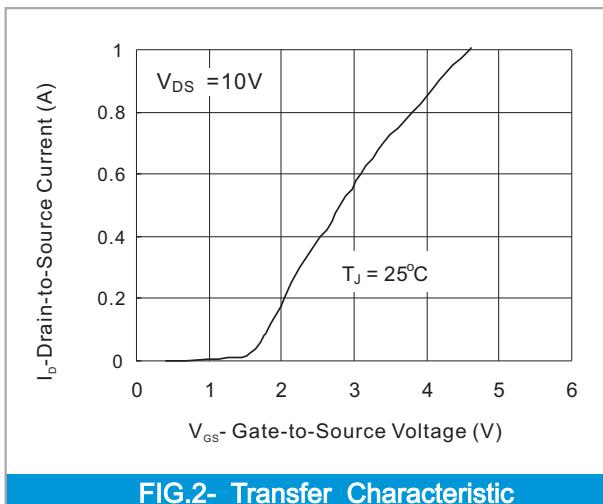


FIG.2- Transfer Characteristic

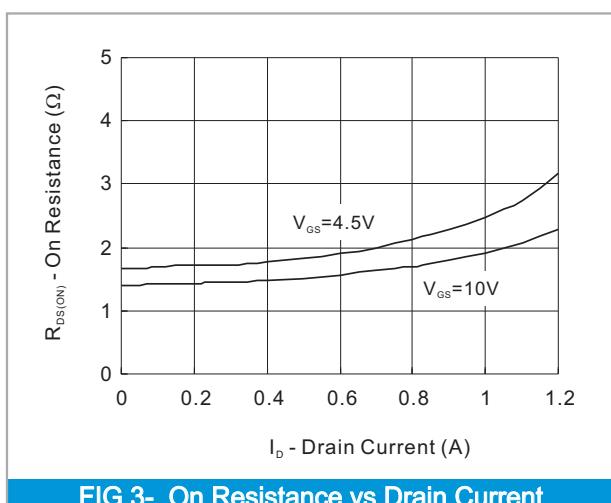


FIG.3- On Resistance vs Drain Current

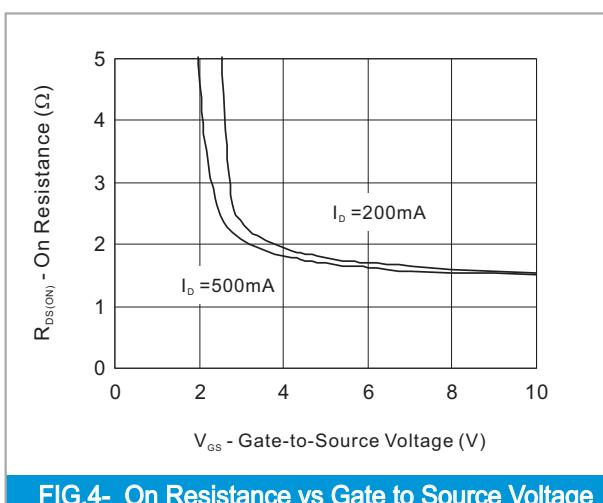


FIG.4- On Resistance vs Gate to Source Voltage

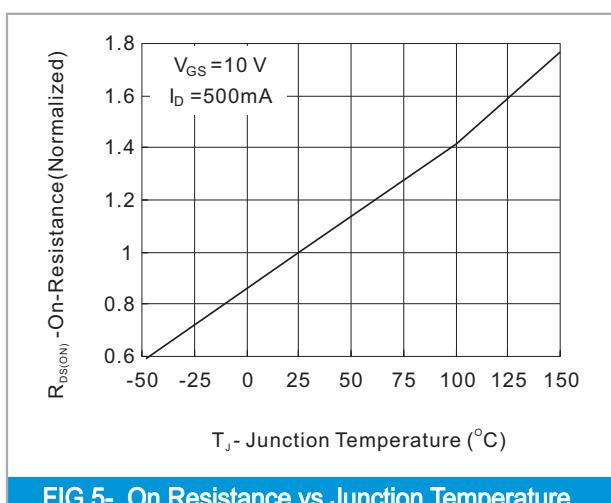


FIG.5- On Resistance vs Junction Temperature



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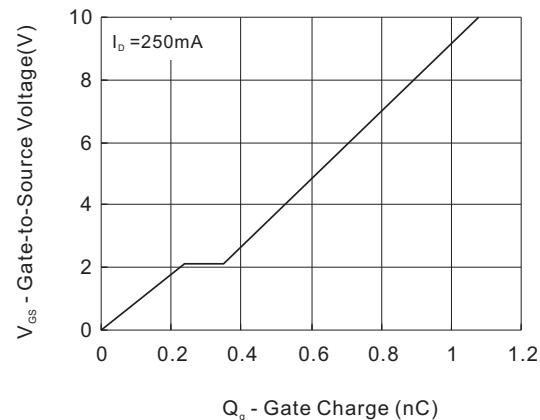


Fig.6 - Gate Charge Waveform

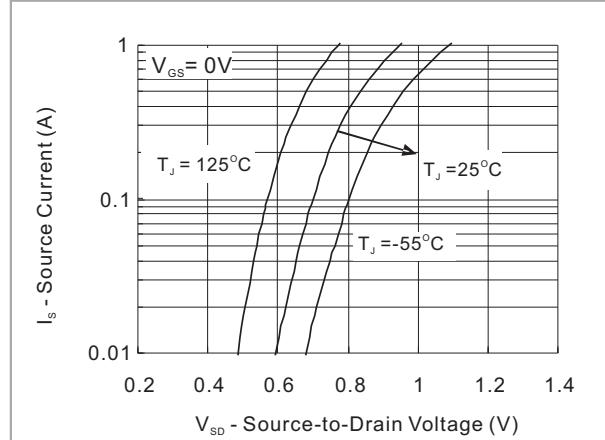


Fig.7 Source-Drain Diode Forward Voltage

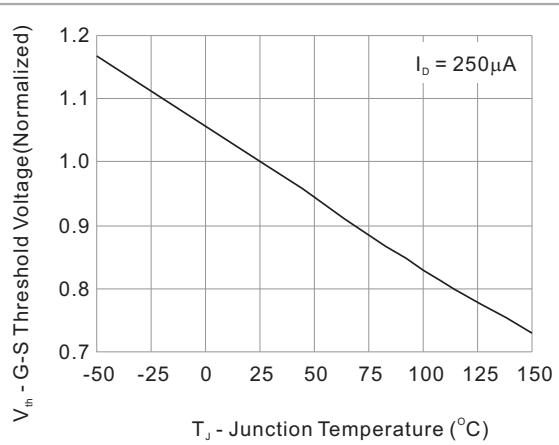


Fig.8 - Threshold Voltage vs Temperature

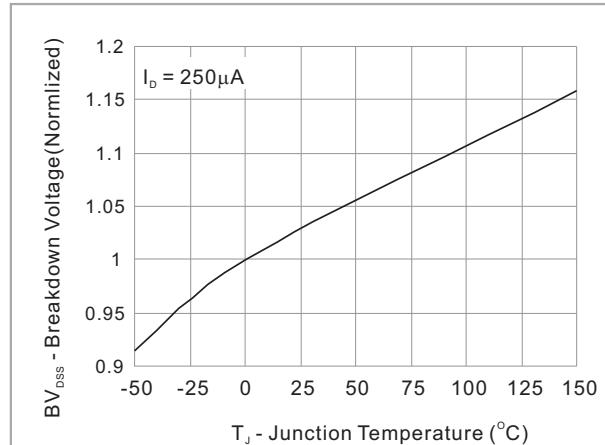


Fig.9 - Breakdown Voltage vs Junction Temperature

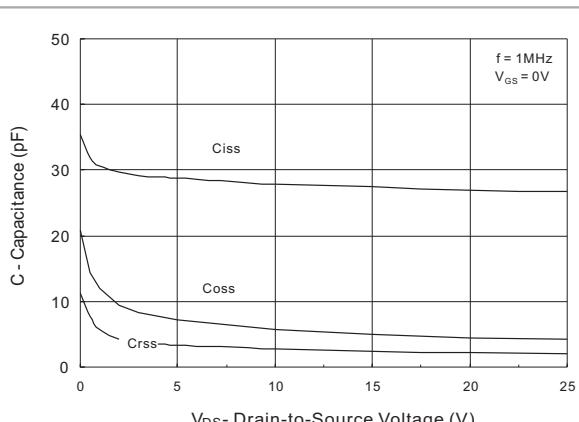
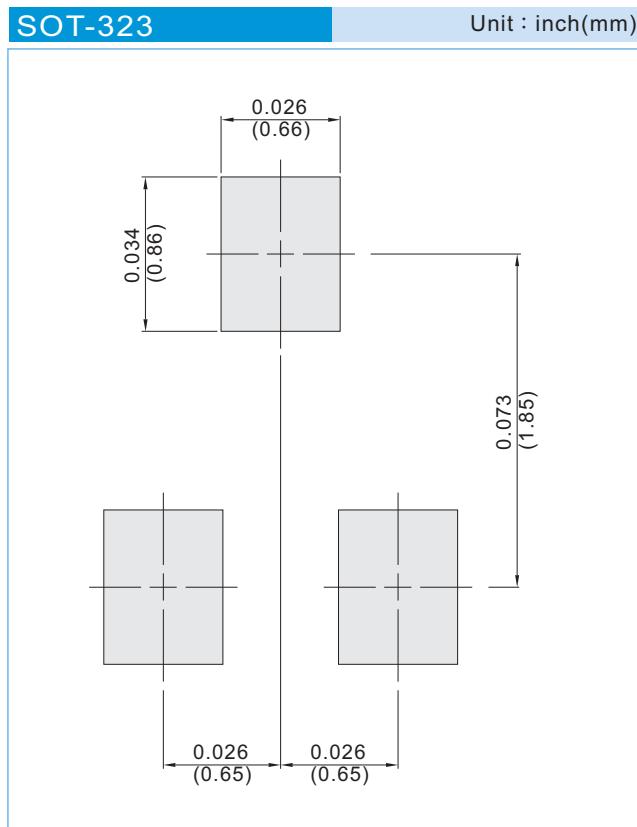


Fig.10 - Capacitance vs Drain to Source Voltage



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MOUNTING PAD LAYOUT



ORDER INFORMATION

- Packing information
 T/R - 12K per 13" plastic Reel
 T/R - 3K per 7" plastic Reel

LEGAL STATEMENT

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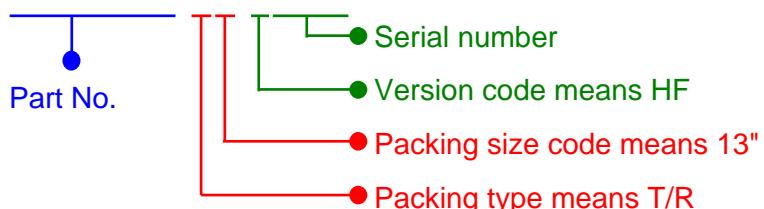


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Part No_packing code_Version

For example :

RB500V-40_R2_0000%



Packing Code XX				Version Code XXXXX		
Packing type	1 st Code	Packing size code	2 nd Code	HF or RoHS	1 st Code	2 nd ~5 th Code
T/B	A	N/A	0	HF	0	serial number
T/R	R	7"	1	RoHS	1	serial number
B/P	B	13"	2			
T/P	T	26mm	X			
TRR	S	52mm	Y			
TRL	L	PBCU	U			
FORMING	F	PBCD	D			